DATA SHEET

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an EMBRON Company \$

Manufacturer: Hatteland Display AS

Product: Compact Fanless Computer

Type: HT B30Kw STC-xyy-Eyyyyy (Short Depth model)

(where w=CPU type, x=OS, y=Configuration)

Last Revised: 19 Dec 2017
Revision#: 04

Compact Fanless Computer

Overview:

The HT B30 range is based on the latest Intel chipset and Skylake processor platform, delivering even more power for maritime technology developers to design and build high-end vessel control and monitoring solutions that enable safer and more effecient maritime operations.

HT B30 computers are available in two new form factors, short depth and long depth, allowing for flexible installation options including 3U rack mounting in pairs. Using the same system architecture as our new, second generation Series X Panel Computers, the HT B30 range offers significant processing speed and graphical performance improvements, which when combined with multiple-drive solid state storage and silent, fanless operation, positioning it among the most advanced computing platforms for maritime applications.

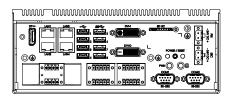
HT B30 computers can be delivered with a choice of three Intel® $Core^{TM}$ processors, up to i7. Graphical output is handled by 1 x DVI-I, 1 x DVI-D and 1 x Display Port (DP) while standard interfaces include 4 x Ethernet Ports, 4 x USB2.0 and 4 x USB3.0. The HT B30 platform also supports a wide range of interface modules such as CAN/NMEA COM/COM and DIO, ensuring it is ready off-the-shelf for all maritime applications. In addition, HT B30K range of computers features a lightweight, fully enclosed aluminium chassis and comes dual DC power input.



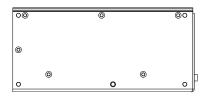
FRONT VIEW



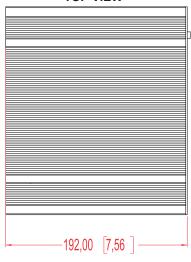
BACK VIEW



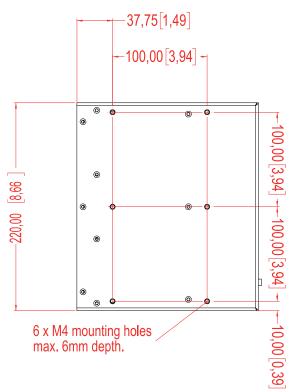
SIDE VIEW



TOP VIEW



BOTTOM VIEW



Dimensions might be shown with or without decimals and indicated as mm [inches]. Tolerance on drawings is +/- 1mm. For accurate measurements, check relevant DWG file.



TECHNICAL DESCRIPTION

Computer Specification	ns: (Standard model)	External Connector Type:		
Operating System	: None or Customized image - See table below	1		
 Processor 	: 1 x Intel® Core™ - See table below	1		
Memory/RAM	: 2 x SO-DIMM DDR4 Slot, Max 2x16GB - See table below			
Storage #1 internal	: 2 x 2.5" SSD - See table below for sizes	i		
 Storage #2 internal 	: 1 x SSD m.2 - See table below for sizes			
 Media Storage 	: 1 x SDHC (SDcard) slot	1 x SDcard Slot		
Graphics	: Intel® HD Graphics 520, OpenGL 4,4, DirectX 12.0, OpenCL 2.0 3 independent displays (valid combinations: ref Intel datasheet)	1 x DVI-I + 1 DVI-D + 1 x DP		
Graphics Res.	: DP 4096x2304@60Hz, DVI-I/D 1920x1200@60Hz	1		
 System Chipset 	: Integrated in 6th Generation Intel® Core™ U-series processor	!		
• BÍOS	: ACPĬ support	1		
• Ethernet #1	: 1 x 10/100/1000Mbps, IntelGigabit LAN	1 x RJ-45, Teaming		
• Ethernet #2	: 1 x 10/100/1000Mbps, IntelGigabit LAN	1 x RJ-45, Teaming		
• Ethernet #3	: 1 x 10/100/1000Mbps, Realtek Gigabit LAN	1 x RJ-45, Teaming		
• Ethernet #4	: 1 x 10/100/1000Mbps, Realtek Gigabit LAN	1 x RJ-45, Teaming		
• USB Ports #1	: 4 x USB2.0 (<5m)	4 x USB Type A		
• USB Ports #2	: 4 x USB3.0 (<3m)	4 x USB Type A		
 Power Manager 	: ACPI S3/S4	i i		
 Watchdog Timer 	: 256 Segments, 0, 1, 2255 sec/min	1		
• RTC	: 0.2s/day**	i		
 H/W Status Mont. 	: Temperatures, voltages, Battery load status Alarm, cooling fan status*. Auto throttling control if CPU overheats			
Battery : Normal operational conditions: life time >5 year, worst case conditions(@70C, 24/7): life time >2 year				
* Cooling FAN status, not applicable for system without CPU/system FAN.				
** Required accuracy may be dependent of the actual implementation/environment and may require calibration to be within specified boundaries.				

Power Specifications:

Dower	Sunni	lv o	ptions:
rowei	Suppl	1 V U	DUOIIS.

Dual DC Input 24VDC, 24V nom, Galvanic isolated, automatic switch between power source

2 x 2-pin Terminal Block 5.08

• Power Consumption** - Operating: 43W (typ)* - 50W (max) - *at 25% load. Max Allowed External USB load = 10W.

Available Computer Configurations:

Туре	Description	Size/Specification		
CPU	1 x Intel® Core™ i5-6300U (2 physical core / 4 thread)	- 2.4GHz / 3GHz 2/4 @15W, 403 GFLOPS, Chipset: Intel® HD 520		
	or Intel® Core™ i7-6600U (2 physical core / 4 thread)	- 2.6GHz / 3.4GHz 2/4 @15W, 403 GFLOPS, Chipset: Intel® HD 520		
	or Intel® Core™ G3955U (2 physical core / 2 thread)	- 2.0GHz 2/2 @15W, 173 GFLOPS, Chipset: Intel® HD 510		
Memory	Dual Channel, DDR4 SO-DIMM, 2 slots available	- 2x4GB (Standard), 2x8GB, 2x16GB (Max)		
Storage #1	2 x 2.5" SSD SATA Multi Level (MLC)	- 150GB (412TBW),240GB (599TBW),480GB (945TBW),960GB (1750TBW)		
		Review "SSD Selection Guide" in manual		
Storage #2	1 x SSD m.2 SATA	- 150GB (412TBW),240GB (599TBW),480GB (945TBW),960GB (1750TBW)		
		Review "SSD Selection Guide" in manual		
OS Option	Windows® 7 Pro/Ult. Embedded Systems*, Windows® Emb. Standard 7 (Toolkit & Runtime) All Versions**, Windows® 10 IoT Enterprise 2016 LTSB***			
32/64bit where	Linux: TBD			
applicable	*Product Distribution End Date September 2024. **Product Distribution End Date July 2025. ***Product Distribution End Date November 2025.			

Factory Mounted Options:

- 1 or 2 x PCA100293-1 (4 x COM RS-422/485 isolated NMEA 4 channel) module
- 1 x HT 00254 OPT-A1 (1 x CAN isolated, 2 channel) module
- 1 x HT 00268 OPT-A1 (4 x Digital Input/Output isolated) module
- 1 x PCA100298-1 (LAN 10/100Mbps, 2 ports (RJ45) module
- 1 x HT 00271 OPT-A1 (2W Amplified Audio out via DB9F) module
- 1 x PS2 Mouse & Keyboard Connector module
- 1 or 2 x RS-232 COM Serial Ports DB9M, isolated module
- TPM2.0 (Trusted Platform Module)
- Variations of SSD Storage, RAM Memory and Operating System
- * Contact us for possible combinations. Review separate datasheet for more info.

Available Accessories:

- HT 00262 OPT-A1: 4 x RS-422/RS-485 isolated, USB ext. module
- HT 00263 OPT-A1: 4 x RS-232 COM non-isolated, USB ext. module
 HT 00364 OPT A1: 1 x CAN isolated, 2 channel, USB ext. module
- HT 00264 OPT-A1: 1 x CAN isolated, 2 channel, USB ext. module
- HT 00273 OPT-A1: 4 x Digital IN/OUT isolated, USB ext. module
 HT 00274 OPT-A1: 2 x LAN 10/100Mbps, RJ45, USB ext. module
- HT 00228 OPT-A1: 1 x Mounting Plate with cable relief, RAL9011
- HT MBK STD-A2: 1 x Mounting Bracket Kit included with delivery
- HT RET STD-A1: 1 x Cable Retainer/Relief Kit included with delivery
- HT RMK STD-A1: 1 x 2U Rack Mount Kit w/brackets, RAL9011
- HT RMK STD-H1: 1 x 2U Rack Mount Kit w/brackets & Handles, RAL9011
- HT SRK STD-A1: 1 x 3U 19" Slide Rack Mount Kit (2xHTB30 side-by-side)
- HT 00224 OPT-A1: 2 x 20" ball bearing sliding rail kit for 19" Rack*

 HT 00225 OPT-A1: 2 x 26" ball bearing sliding rail kit for 19" Rack*
- JH C01MF A-A: 1 x USB Cable 1m, Type A to Chassis mount receptacle
- HT 00300 MSOS: OS options -> http://www.hatteland-display.com/os
- *Must be combined with HT SRK STD-A1

MECHANICAL DESCRIPTION

Physical Specifications:

- W:220.00 [8.66"] x H:89.00 [3.50"] x D:192.00 [7.56"] mm [inch]
- Weight: 2.5 kg / 5.5lbs
- Aluminium Cooling Chassis
- Includes: Mounting Bracket Kit, USB + DP/HDMI Retainers, Cable Relief Retainer
- Combined Power/Reset Button, Power LED, Activity LED SSD

Environmental Considerations:

- Operating
 Storage
 Humidity
 Temperature -15 deg. C to +55 deg. C
 Temperature -20 deg. C to +60 deg. C
 Up to 95% (Operating / Storage)
- Compass Safe Distance : Standard 30cm Steering: 25cm

Lifetime Considerations:

Even although the test conditions for bridge units provide for a maximum operating temperature of 55°C, continuous operation of all electronic components should, if possible, take place at ambient temperatures of only 25°C. This is a necessary prerequisite for long life and low service costs.

APPROVALS & CERTIFICATES

These products have been tested / type approved by the following classification societies (*=pending):

IEC 60945 4th (EN 60945:2002)*

IACS E10*

EN55024*

EN55022, Class A*

EU RO MR - Mutual Recognition*

^{**}Power Consumption: Numbers are specified as the unit is delivered from factory. All additional installed equipment like USB, PCIe and similar loads have to be added to power consumption. Note that total extra load have to be multiplied by 1.5 to compensate for efficiency in internal power converters. Typical power consumption varies a lot with computer load. We measure with 25% of max computer load.